LETTER

Solid‑ink‑based print‑and‑peel method for microfuidic fabrication: a revisit

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Abstract

The print-and-peel (PAP) method enables faster and cheaper fabrication of microfuidic devices, because this non-lithographic method uses a commercial printer to print channel mold patterns onto transparency flm for use as a mold for microfuidic device fabrication. This study revisits the solid-ink-based PAP method by characterizing solid link patterns printed on transparency flms for cross-sectional shape, height, and surface roughness. In addition, the method was applied to create functional microfuidic devices to show that this low-cost method can be used for microfuidic applications.

Keywords Image processing · Microchannel · Non-lithographic microfuidic mold · Soft lithography · Surface topography · Wax printing

1 Introduction

Microfuidic devices have been widely employed because of their unique fow environments, but their use can be limited by fabrication difficulties with photo-lithography which requires specialized equipment in a clean-room environment. As an alternative non-lithographic approach, the print-and-peel (PAP) method was developed for easier and cheaper fabrication of microchannel devices [\[1](#page-5-0)]. This method involves generating channel patterns in a computeraided design (CAD) program, making a mold by printing the channel pattern with a feature height of about 10 µm onto a transparency flm, and curing polydimethylsiloxane (PDMS) over the mold. It is known that resulting mold surfaces have substantial roughness depending on the choice of printing technology.

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Two types of office-grade printers have been used for the PAP method: laser printer $[2-5]$ $[2-5]$ and solid-ink printer $[6-8]$ $[6-8]$. Although laser printers can produce microfuidic molds based on the PAP method, solid-ink printers have an advantage that their solid ink can be printed on nearly any media [[9\]](#page-5-5). In addition, solid-ink printers print features with less roughness compared to laser printers [\[1](#page-5-0)]. In particular, this study focuses on the solid-ink-based PAP method.

Kaigala et al. proposed using a solid-ink printer for the PAP method [[6\]](#page-5-3). They used a solid-ink printer for smooth features with a highest resolution setting of 2400 dpi, and tested regular Mylar flm and specialized transparency flm (Xerox Phaser solid-ink professional). They observed irregularity in printed solid-ink patterns due to occasional gaps in ink-coverage and rastering of the printing process. Thus, they proposed thermal treatment (warming the printed transparency for 10 min at 100 $^{\circ}$ C) to cause reflow of the solid ink and thus to further smoothen solid-ink reliefs. Kaigala et al. used a stylus proflometer to show that solid-ink features became smoother by the thermal treatment and had a maximum height of about 10 μm. They also recommended the specialized transparency flm, because it had negligible number of speckles in contrast to Mylar flm having random dark spots.

Despite promising results, however, Kaigala et al. [\[6](#page-5-3)] and following studies [\[7](#page-5-6), [8](#page-5-4)] did not provide rigorous numerical data on the height and surface roughness of solid-inkbased microfuidic mold features, which is critical for other

researchers to adopt the method. Therefore, this paper aims to further characterize the PAP method with solid-ink printing and to showcase applications of the method.

2 Materials and methods

2.1 Characterization of solid‑ink patterns

Square patterns of $1.5 \text{ mm} \times 1.5 \text{ mm}$ were printed on transparency flm in four diferent colors: cyan, yellow, magenta, and black with a solid-ink printer (Xerox ColorQube 8570) in the enhanced print-quality mode. Following Kaigala et al., two types of transparency flm were used: Phaser solid-ink professional transparency flm (Xerox) which is specialized for solid-ink printing, and Apollo laser printer transparency flm (ACCO Brands) which is a generic brand. Kaigala et al. suggested heat treatment on solid-ink patterns for smoother surface [\[6](#page-5-3)], so we performed thermal treatment to some patterns by placing them on a hot plate at 80 °C for 10 min.

The surface of the printed squares was imaged using a laser confocal scanning microscope (LCSM; Keyence VK-X200 K) at 10×magnifcation. The lateral resolution and vertical resolution of the LCSM were 1.4 μm and 0.1 nm, respectively. This vertical resolution is comparable to that of a typical stylus profler, while the lateral resolution is about one order of magnitude lower than that of the stylus profler. Although it was possible to achieve higher lateral resolution with the LCSM using a lens with higher magnification, $10 \times$ magnification was chosen considering imaging time and solid-ink pattern size.

2.2 Image processing

The height and surface roughness of the solid-ink patterns were determined by image processing (Fig. [1\)](#page-1-0). Obtained images were pre-processed using VK Analyzer (Keyence) for tilt correction and median-flter-based noise removal (Fig. [1a](#page-1-0)).

Then, images were imported as a .csv fle into MATLAB (MathWorks), and converted and normalized in the gray scale to increase contrast between the pattern and background (Fig. [1b](#page-1-0)). A minimum bounding rectangle was ftted to the binary image of the imported image [[10](#page-5-7)] to determine the center and angle of rotation of the pattern (Fig. [1](#page-1-0)c), and the imported image was rotated with respect to the center of the bounding box to be parallel to horizontal and vertical axes (Fig. [1](#page-1-0)d).

The height of the solid-ink pattern was determined as follows. The location of the flm surface was determined by ftting a horizontal plane against the pixels outside the bounding box, and the flm surface was found not to be at zero in the *z*-direction (Fig. [1e](#page-1-0)). Therefore, the image was adjusted, so that the *z* location of the flm surface would

Fig. 1 MATLAB-based image processing to determine the height and surface roughness of solid-ink patterns. **a** Laser confocal scanning microscopy (LCSM) image of a solid-ink pattern. **b** Normalized

image in the gray scale. **c** Binary conversion, boundary detection, and bounding box determination. **d** Rotated image. **e** Film surface determination. **f** Top surface determination

be zero (Fig. [1f](#page-1-0)). Then, the top surface of the ink pattern was determined by iterative plane fitting (Fig. [1](#page-1-0)f). In this process, the plane ftting was done frst against the pixels in the bounding box, and repeated for the pixels above the ftting plane until the vertical location of the ftting plane approached a certain value. Then, the height of the pattern (*H*) was determined, as shown in Fig. [1](#page-1-0)f.

Averaged cross-section of the pattern was determined by averaging cross-sections in either *x*- or *y*-directions across a half of the pattern (Fig. [2a](#page-2-0) top left panel; *x-* and *y*-directions are shown in Fig. [1e](#page-1-0)). Then, the region of interest for surface roughness estimation was determined by identifying the intersection points of the average cross-sections with the found top plane. Finally, the root-mean-square surface roughness $(\varepsilon_{\text{rms}})$ of the pattern was calculated from the region of interest.

2.3 Channel fabrication using soft lithography

Three microfuidic devices were fabricated using the PAP method: straight channel, Y channel, and serpentine channel. Channel designs were printed in black solid ink on the generic transparency flm. A non-stick coating was applied using (tridecafuoro-1,1,2,2-tetrahydrooctyl)-1-trichlorosilane (T2492-KG, United Chemical Specialties). PDMS (Dow Corning Sylgard 184; 10:1 weight ratio of monomer and the curing agent) was poured on the mold, degassed, cured overnight at room temperature, and then cured at 55 °C for 1-2 h. PDMS curing at higher temperature resulted in adhesion of solid ink on PDMS.

The PDMS was peeled from the mold, and inlet and outlet holes were punched with a 0.5 mm biopsy punch. The channel body was bonded to a slide glass using plasma activation. The device was connected to syringes using silicon tubing (Cole-Parmer), and dyed water was injected into the device using a syringe pump (Chemyx Fusion 200).

3 Results

3.1 Height and roughness of solid‑ink patterns

LCSM imaging captured successfully the shape and surface roughness of the solid-ink patterns. Figure [2](#page-2-0) shows black solid-ink patterns printed on the generic (Apollo) and specialized (Xerox) transparency flm with and without heat treatment as examples. The optical images of as-is solid-ink patterns show raster lines from printing on the both transparency flm types, as reported by the previous studies [\[6](#page-5-3)]. The LCSM images show that the raster lines were actually protruding (or convex, higher than the rest of the surface). Uneven wavy edges were present in the direction of the raster lines. Both transparency flm types had visual imperfections on their surfaces, in contrast to the observation of Kaigala et al. [[6\]](#page-5-3), which might have affected the roughness of the printed pattern.

The developed MATLAB-based image processing successfully quantifed the dimension and surface roughness of the sample patterns. The lateral dimension of the pattern was measured to be about 1.5 mm, similar to the intended size. Average cross-sectional images were obtained by averaging cross-sections of a pattern in the raster line direction and its normal direction (red and blue arrows in Fig. [2,](#page-2-0) respectively) using its LCSM image. The raster lines observed in

Fig. 2 Surface topography and height of square solid-ink patterns. **a** Generic flm (Apollo laser printer transparency flm). **b** Specialized flm (Xerox Phaser solid-ink professional transparency flm). Results of each case are shown in the order of optical image of the pattern, the surface topography image of the pattern (color bar shown on the right end of the fgure), and the averaged cross-sectional image of

the pattern (the dashed boxes and arrows in the frst image show the averaging direction and area for the cross-section plot; the horizontal dashed lines show the height of the solid-ink pattern determined in Fig. [1\)](#page-1-0). *H* pattern height, *εrms* root-mean-square roughness of pattern surface

microscopy images can be seen in the cross-sectional image averaged in the raster line direction, whereas the other averaged cross-section shows less conspicuous roughness pattern. The both cross-sections are in approximate trapezoidal shapes, which are ideal for microfuidics, and they agree well with the top surface of the solid-ink pattern, which was found by the iterative plane ftting process done against the whole solid-ink pattern (dashed lines in the cross-section plots of Fig. [2](#page-2-0)).

Some of the prepared samples were heat treated following the method of Kaigala et al. [\[6](#page-5-3)]. The thermal treatment was found to have smoothened the surface of the solid-ink patterns somewhat (Fig. [2\)](#page-2-0). However, the height and surface roughness of the heat-treated samples were not diferent from those of non-treated ones. In addition, the thermal treatment sometimes resulted in undesirable efects on solid-ink patterns such as unevenness in height or surface roughness. Therefore, we exclude heat-treated samples in the following analysis and device fabrication.

To determine the range of the height and surface roughness of solid-ink molds for microfuidics, 4 or 5 solid-ink square patterns of four diferent colors were imaged using LSCM. The height and surface roughness range of the solidink patterns were about 17 μ m and 45–55 nm, respectively (Table [1](#page-3-0)). Our height measurement agrees well with the previous studies (Kaigala et al. $[6]: \sim 10 \mu m$ $[6]: \sim 10 \mu m$, Thomas et al. [[1,](#page-5-0) [8\]](#page-5-4): 10–15 μ m). There were no significant differences between color of solid-ink patterns in terms of height or roughness.

3.2 Minimum channel width

In terms of practical applications of the PAP method, it is important to know the minimum channel width achievable with the method. Straight microchannels with diferent channel widths were fabricated and tested by injecting red-dyed water through the channels (Fig. [3](#page-3-1)a). It was found that water could fow through even the 0.1 mm-wide channel.

To confrm our observation, we measured the width of straight lines printed in solid ink (Fig. [3b](#page-3-1)). The actual width of 0.01, 0.05, 0.1, 0.2, 0.3, and 0.5 mm-wide lines was

Table 1 Height and roughness of printed solid-ink patterns $(mean \pm std)$

| | Generic film | | Specialized film | |
|--------------|------------------|-------------------|------------------|-------------------|
| | Height (μm) | Roughness (nm) | Height (μm) | Roughness (nm) |
| Black | $16.6 + 0.2$ | $54.6 + 3.3$ | $16.6 + 0.2$ | $44.7 + 6.3$ |
| Cyan | $17.9 + 0.3$ | $50.4 + 8.8$ | $17.8 + 0.2$ | $45.2 + 5.9$ |
| Magenta | $17.6 + 0.1$ | $52.0 + 8.0$ | $17.8 + 0.1$ | $52.0 + 19.0$ |
| Yellow | $16.9 + 0.6$ | 47.5 ± 5.4 | $16.8 + 0.4$ | $50.6 + 7.5$ |

Fig. 3 Minimum width of channels fabricated with the solid-inkbased print-and-peel method. **a** Straight channel test to determine the minimum channel width for fuid fow. **b** Measurement of the width of solid-ink lines using a calibration slide (one grid=0.1 mm). Numbers shown in blue are the design values for the channel width (unit: mm)

measured to be around 0.2, 0.2, 0.3, 0.4, 0.4, and 0.5 mm, respectively. This result shows that the actual width of printed channels was larger than the design value when they were designed to be narrower than 0.5 mm, and the achievable minimum channel with the employed PAP method is about 200 μm. Our result agrees well with the results of Thomas et al. $[1, 8]$ $[1, 8]$ $[1, 8]$ $[1, 8]$. They measured the channels made of the solid-ink-based PAP method to be $250 \mu m$ [[8\]](#page-5-4). In addition, they showed that the minimum line width of solid-ink patterns was about 300 μm [[1](#page-5-0)]. Kaigala et al. also pointed out that the smallest widths achievable with office-grade solid-ink printers were \sim 300 μ m [\[6](#page-5-3)].

3.3 Examples of fabricated devices

Microfuidic devices were successfully fabricated with the PAP method. Red and green dyes were able to be perfused through the two inlets of the Y channel (Fig. [4](#page-4-0)a), and mixing between the two colors was very limited in the main channel as seen by the clear separation between the colors. To test the observed limited mixing, we fabricated a very long serpentine channel (Fig. [4b](#page-4-0)). Although the channel length was much longer than the Y channel, the two colors were still separated till the outlet. We also fabricated Christmas tree microchannel devices which are widely used for generating concentration gradient, but no clear concentration gradient was created due to limited mixing.

The inset of Fig. [4a](#page-4-0) shows that the surface roughness pattern of the solid-ink mold was also seen in the surface of the fabricated channel. We compared LCSM images of a solid-ink mold and a PDMS replica of the mold to check how well soft lithography could replicate the mold in the

Fig. 4 Microfuidic channels fabricated with the solid-ink-based print-and-peel method. **a** Y channel showing limited mixing between two colors. Inset: microscopic image of the PDMS channel surface showing surface roughness and raster lines imprinted by solid-ink mold. **b** About 100 mm-long serpentine channel showing limited mixing. **c** Comparison of a solid-ink mold and its PDMS replica. *h* the channel height

solid-ink-based PAP method. As shown in Fig. [4](#page-4-0)c, the PDMS replica overall maintained the key features of the solid-ink mold except smudged features along the perimeter. The height of the PDMS replica was about 6% lower than that of the mold, whereas the surface roughness increased by 27%.

However, it is expected that this level of roughness of the channel surface cannot afect the fow signifcantly for two reasons. First, the relative surface roughness was about ε _{rms}/*h* \approx 0.003, which has negligible effects even for high Reynolds number fows. Here, *h* is the channel height. Second, laminar fows are not disturbed by surface roughness [[5\]](#page-5-2). As shown in Fig. [4](#page-4-0)a and b, laminar fow in the long channel was not disturbed by the rough surface.

The observed limited mixing can be understood by estimating the fow distance of the fuids through the channel required for complete mixing. The width (*w*) of the serpentine channel was 0.5 mm. The inject volume flow rate (Q) was 0.05 ml/min, and thus, the average fow speed (*V*) was 0.11 m/s with the approximate channel height of $15 \mu m$. The mixing time across the channel can be estimated using $t_{\text{mix}} \sim w^2/D$, where *D* is the diffusion coefficient [[11](#page-5-8)]. With a typical *D* value for ions $(2 \times 10^{-9} \text{ m}^2/\text{s})$ [[11](#page-5-8)], t_{mix} was found to be \sim 125 s. During t_{mix} , the fluid would have flowed over ~ 14 m (= Vt_{mix}) which is two orders of magnitude longer than the channel length (≈ 0.1 m). Therefore, complete mixing cannot be achieved in this channel even with

the high *D* value. In this case, the Péclet number (*Pe*=*Vw*/*D* [[11\]](#page-5-8)) was about 2.75×10^4 .

4 Discussion

The PAP method is an alternative microfuidic mold fabrication method for photo-lithography, which can decrease the total fabrication cost and time of microfuidic devices. When the method was proposed, laser printers were used to print out CAD-designed mold on a transparency film $[2-5]$ $[2-5]$. Channel reliefs made of toner particles were found to have a trapezoidal cross-section with a height of 6–14 µm and a surface roughness of 0.2–1.2 μ m.

Solid-ink printers were also employed for the PAP method, and solid-ink-relief of printed molds was found to be smoother than those printed by laser printers [[8](#page-5-4)]. Another advantage of solid-ink printing is that solid ink can be printed on virtually all types of media, including paper and plastic flm [\[9](#page-5-5)].

Solid ink is commonly made from a combination of paraffin wax, resin, and dye $[12]$, and it has a typical melting temperature of around 90 °C [\[9](#page-5-5), [12](#page-5-9), [13\]](#page-5-10). Kaigala et al. proposed warming solid-ink molds for 10 min at 100 °C to decrease the roughness of solid-ink reliefs, and they pointed out that a specifc condition for the thermal treatment needs to be determined empirically [[6\]](#page-5-3). We tried the proposed thermal treatment method and found that 100 °C was too high. After thermal treatment at 100 °C, solid-ink reliefs showed signifcant changes in their shape due to signifcant refow of molten solid ink. For instance, the solid-ink patterns were in the trapezoidal pyramid shape, as shown in Fig. [2,](#page-2-0) but their shape changed to the mound shape after the 100 °C thermal treatment. Li et al. measured that the viscosity of solid inks significantly decreased around 90 $^{\circ}$ C [\[13](#page-5-10)]. Therefore, we decreased the temperature for the thermal treatment to 80 °C and could avoid the reflow problem. However, no significant differences in feature height and surface roughness were found between as-printed patterns and thermally treated patterns (Fig. [2\)](#page-2-0).

The aforementioned relatively low melting point of the solid-ink limits curing of PDMS over the solid-ink-printed masters at elevated temperature [\[1\]](#page-5-0). We found that molten solid ink was left on cured PDMS when PDMS was cured at 80 °C on solid-ink-printed channel molds. Therefore, we cured PDMS at room temperature overnight and then at 55 °C for 1–2 h.

Kaigala et al. recommended using Xerox Phaser solidink professional transparency flm, specialized for solidink printers, because generic Mylar flm showed random dark spots [[6\]](#page-5-3). According to the manufacturer of the used solid-ink printer $[14]$ $[14]$ $[14]$, the Phaser transparency film is more receptive to solid-ink features, whereas generic transparency

flms leave raised edges of ink features. Accordingly, we compared the specialized flm and the generic transparency flm (Apollo). Our imaging and analysis showed negligible diference between the two flm types (Table [1](#page-3-0) and Fig. [2](#page-2-0)). Therefore, we think that the generic transparency flm can be used for the medium to print solid-ink channel patterns.

The solid-ink-based PAP method was successfully used for fabricating a few simple microfuidic channels. We found that the minimum channel width achievable with the method was about 200 μ m (Fig. [3b](#page-3-1)) and that the actual channel height was about 15 μ m (Fig. [4c](#page-4-0)). Based on these results, the minimum aspect ratio of the microchannel achievable using the solid-ink-based PAP method was estimated to be about 13. According to Thomas et al. [\[1](#page-5-0)], solid-ink printers could not print out features with lateral dimensions smaller than \sim 200 μ m. Our experiments using the Y channel and the serpentine channel showed that injected red and green dyed water were clearly separated all through the channels because of very small channel height (Fig. [4](#page-4-0)a, b). Similarly, Thomas et al. did not observe even partial mixing in the PAP-fabricated microchannels at a relatively high volume flow rate of 0.4 ml/min $[8]$ $[8]$.

5 Conclusion

The solid-ink-based PAP method is an effective nonlithographic method for easier and cheaper fabrication of microfuidics master mold. To provide potential users of this method with reference data, we characterized solid-inkbased master molds printed on transparency flm using laser confocal scanning microscopy and automated image processing. The typical height and surface roughness of printed solid-ink molds were \sim 17 µm and \sim 50 nm, respectively. Heat treatment on printed solid-ink patterns did not improve mold surface signifcantly, and the type of used transparency types did not afect mold surface quality signifcantly. We could apply the solid-ink-based PAP method successfully for real microfuidic device fabrication.

Although this method's low cost and ease-of-use lead to it being an inexpensive, promising alternative to other common fabrication methods, the method has major limitations: the thickness of fabricated molds is fixed at \sim 17 μ m with surface roughness of \sim 50 nm, and the channel width cannot be smaller than 200 µm. These limitations result in relatively high aspect ratio of fabricated channels, and very limited mixing in channels. Therefore, the solid-ink-based PAP method needs to be employed with these limitations considered.

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Compliance with ethical standards

Conflict of interest On behalf of all authors, the corresponding author states that there is no confict of interest.

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